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Kind regards,

Team Nexperia

Logic level TOPFET
SMD version of BUK104-50L/S

BUK114-50L/S

DESCRIPTION

Monolithic temperature and overload protected logic level power MOSFET in a 5 pin surface mounting plastic envelope, intended as a general purpose switch for automotive systems and other applications.

APPLICATIONS

- General controller for driving
- lamps
 - motors
 - solenoids
 - heaters

FEATURES

- Vertical power DMOS output stage
- Low on-state resistance
- Logic and protection supply from separate pin
- Low operating supply current
- Overload protection against over temperature
- Overload protection against short circuit load
- Latched overload protection reset by protection supply
- Protection circuit condition indicated by flag pin
- 5 V logic compatible input level
- Separate input pin for higher frequency drive
- ESD protection on input, flag and protection supply pins
- Over voltage clamping for turn off of inductive loads
- Both linear and switching operation are possible

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V_{DS}	Continuous drain source voltage	50	V
I_D	Continuous drain current	15	A
P_{tot}	Total power dissipation	40	W
T_j	Continuous junction temperature	150	°C
$R_{DS(ON)}$	Drain-source on-state resistance		
	$V_{IS} = 5\text{ V}$	125	mΩ
	$V_{IS} = 7\text{ V}$	100	mΩ
SYMBOL	PARAMETER	NOM.	UNIT
V_{PSN}	Protection supply voltage		
	BUK114-50L	5	V
	BUK114-50S	10	V

FUNCTIONAL BLOCK DIAGRAM

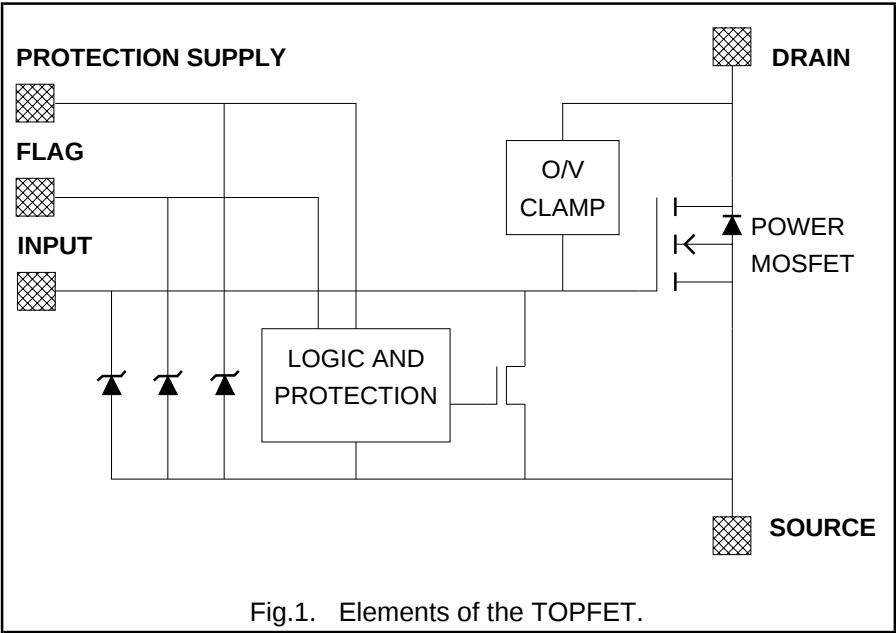


Fig.1. Elements of the TOPFET.

PINNING - SOT426

PIN	DESCRIPTION
1	input
2	flag
3	(connected to mb)
4	protection supply
5	source
mb	drain

PIN CONFIGURATION

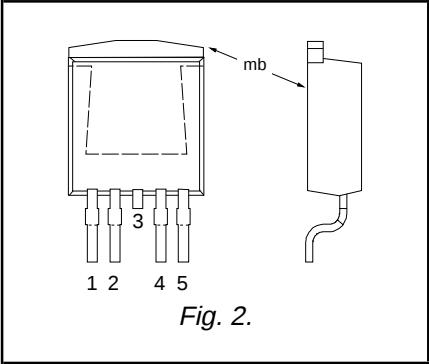


Fig. 2.

SYMBOL

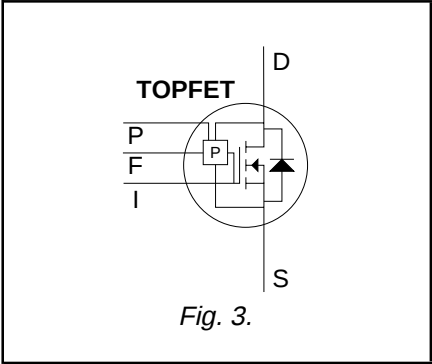


Fig. 3.

Logic level TOPFET

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LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.	UNIT
V_{DSS}	Voltages Continuous off-state drain source voltage ¹	$V_{IS} = 0 \text{ V}$	-		50	V
V_{IS}	Continuous input voltage	-	0		11	V
V_{FS}	Continuous flag voltage	-	0		11	V
V_{PS}	Continuous supply voltage	-	0		11	V
	Currents	$V_{IS} =$	-	7	5	V
I_D	Continuous drain current	$T_{mb} \leq 25 \text{ }^\circ\text{C}$	-	15	13	A
I_D	Continuous drain current	$T_{mb} \leq 100 \text{ }^\circ\text{C}$	-	9.5	8.5	A
I_{DRM}	Repetitive peak on-state drain current	$T_{mb} \leq 25 \text{ }^\circ\text{C}$	-	60	54	A
	Thermal					
P_{tot}	Total power dissipation	$T_{mb} = 25 \text{ }^\circ\text{C}$	-		40	W
T_{stg}	Storage temperature	-	-55		150	$^\circ\text{C}$
T_j	Junction temperature ²	continuous	-		150	$^\circ\text{C}$
T_{sld}	Lead temperature	during soldering	-		250	$^\circ\text{C}$

OVERLOAD PROTECTION LIMITING VALUES

With the protection supply connected, TOPFET can protect itself from two types of overload - over temperature and short circuit load.

An n-MOS transistor turns on between the input and source to quickly discharge the power MOSFET gate capacitance.

For internal overload protection to remain latched while the control circuit is high, external series input resistance must be provided. Refer to INPUT CHARACTERISTICS.

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.	UNIT
V_{PSP}	Protection supply voltage ³	$V_{IS} =$	7	5	-	V
		for valid protection	4.4	4	-	V
		BUK114-50L BUK114-50S	5.4	5	-	V
$V_{DDP(T)}$	Over temperature protection Protected drain source supply voltage	$V_{PS} = V_{PSN}$	-		50	V
		$V_{IS} = 10 \text{ V}; R_i \geq 2 \text{ k}\Omega$ $V_{IS} = 5 \text{ V}; R_i \geq 1 \text{ k}\Omega$	-		50	V
$V_{DDP(P)}$	Short circuit load protection Protected drain source supply voltage ⁴	$V_{PS} = V_{PSN}; L \leq 10 \text{ }\mu\text{H}$	-		25	V
		$V_{IS} = 10 \text{ V}; R_i \geq 2 \text{ k}\Omega$	-		45	V
		$V_{IS} = 5 \text{ V}; R_i \geq 1 \text{ k}\Omega$	-		0.8	kW
P_{DSM}	Instantaneous overload dissipation		-		0.8	kW

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_C	Electrostatic discharge capacitor voltage	Human body model; $C = 250 \text{ pF}; R = 1.5 \text{ k}\Omega$	-	2	kV

¹ Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

² A higher T_j is allowed as an overload condition but at the threshold $T_{j(TO)}$ the over temperature trip operates to protect the switch.

³ The minimum supply voltage required for correct operation of the overload protection circuits.

⁴ The device is able to self-protect against a short circuit load providing the drain-source supply voltage does not exceed $V_{DDP(P)}$ maximum. For further information, refer to OVERLOAD PROTECTION CHARACTERISTICS.

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OVERVOLTAGE CLAMPING LIMITING VALUES

At a drain source voltage above 50 V the power MOSFET is actively turned on to clamp overvoltage transients.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{DRRM}	Repetitive peak clamping drain current	$R_{\text{IS}} \geq 100 \Omega^1$	-	15	A
E_{DSM}	Non-repetitive inductive turn-off energy ²	$I_{\text{DM}} = 15 \text{ A}; R_{\text{IS}} \geq 100 \Omega$	-	200	mJ
E_{DRM}	Repetitive inductive turn-off energy	$R_{\text{IS}} \geq 100 \Omega; T_{\text{mb}} \leq 95^\circ \text{C};$ $I_{\text{DM}} = 4 \text{ A}; V_{\text{DD}} \leq 20 \text{ V};$ $f = 250 \text{ Hz}$	-	20	mJ
I_{DIRM}	Repetitive peak drain to input current ³	$R_{\text{IS}} = 0 \Omega; t_p \leq 1 \text{ ms}$	-	50	mA

REVERSE DIODE LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{S}	Continuous forward current	$T_{\text{mb}} = 25^\circ \text{C};$ $V_{\text{IS}} = V_{\text{PS}} = V_{\text{FS}} = 0 \text{ V}$	-	15	A

THERMAL CHARACTERISTIC

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{\text{th j-mb}}$	Thermal resistance Junction to mounting base	-	-	2.5	3.1	K/W

STATIC CHARACTERISTICS

$T_{\text{mb}} = 25^\circ \text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(\text{CL})\text{DSR}}$	Drain-source clamping voltage	$R_{\text{IS}} = 100 \Omega; I_{\text{D}} = 10 \text{ mA}$	50	-	65	V
$V_{(\text{CL})\text{DSR}}$	Drain-source clamping voltage	$R_{\text{IS}} = 100 \Omega; I_{\text{DM}} = 1 \text{ A}; t_p \leq 300 \mu\text{s};$ $\delta \leq 0.01$	50	-	70	V
I_{DSS}	Zero input voltage drain current	$V_{\text{DS}} = 12 \text{ V}; V_{\text{IS}} = 0 \text{ V}$	-	0.5	10	μA
I_{DSR}	Drain source leakage current	$V_{\text{DS}} = 50 \text{ V}; R_{\text{IS}} = 100 \Omega;$	-	1	20	μA
I_{DSR}	Drain source leakage current	$V_{\text{DS}} = 40 \text{ V}; R_{\text{IS}} = 100 \Omega;$ $T_{\text{J}} = 125^\circ \text{C}$	-	10	100	μA
$R_{\text{DS(ON)}}$	Drain-source on-state resistance	$I_{\text{DM}} = 7.5 \text{ A};$ $t_p \leq 300 \mu\text{s}; \delta \leq 0.01$	-	75	100	$\text{m}\Omega$
		$V_{\text{IS}} = 7 \text{ V}$ $V_{\text{IS}} = 5 \text{ V}$	-	95	125	$\text{m}\Omega$

1 The input pin must be connected to the source pin by a specified external resistance to allow the power MOSFET gate source voltage to become sufficiently positive for active clamping. Refer to INPUT CHARACTERISTICS.

2 While the protection supply voltage is connected, during overvoltage clamping it is possible that the overload protection may operate at energies close to the limiting value. Refer to OVERLOAD PROTECTION CHARACTERISTICS.

3 Shorting the input to source with low resistance inhibits the internal overvoltage protection by preventing the power MOSFET gate source voltage becoming positive.

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OVERLOAD PROTECTION CHARACTERISTICS

With adequate protection supply voltage TOPFET detects when one of the overload thresholds is exceeded.

Provided there is adequate input series resistance it switches off and remains latched off until reset by the protection supply pin.

Refer also to OVERLOAD PROTECTION LIMITING VALUES and INPUT CHARACTERISTICS.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$E_{DS(TO)}$	Short circuit load protection ¹	$V_{PS} = V_{PSN}^2$; $T_{mb} = 25\text{ °C}$; $L \leq 10\text{ }\mu\text{H}$; $R_1 \geq 2\text{ k}\Omega$				
t_{dsc}	Overload threshold energy	$V_{DD} = 13\text{ V}$; $V_{IS} = 10\text{ V}$	-	150	-	mJ
	Response time	$V_{DD} = 13\text{ V}$; $V_{IS} = 10\text{ V}$	-	375	-	μs
$T_{J(TO)}$	Over temperature protection	$V_{PS} = V_{PSN}$; $R_1 \geq 2\text{ k}\Omega$	150	-	-	$^{\circ}\text{C}$
	Threshold junction temperature	from $I_D \geq 0.65\text{ A}^3$				

TRANSFER CHARACTERISTICS

$T_{mb} = 25\text{ °C}$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
g_{fs}	Forward transconductance	$V_{DS} = 10\text{ V}$; $I_{DM} = 7.5\text{ A}$ $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.01$	5	9	-	S
I_D	Drain current ⁴	$V_{DS} = 13\text{ V}$; $V_{IS} = 5\text{ V}$	-	25	-	A
		$V_{IS} = 10\text{ V}$		40	-	A

PROTECTION SUPPLY CHARACTERISTICS

$T_{mb} = 25\text{ °C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{PS} , I_{PSL}	Protection supply Protection supply current	normal operation or protection latched				
		BUK114-50L $V_{PS} = 5\text{ V}$	-	0.2	0.35	mA
		BUK114-50S $V_{PS} = 10\text{ V}$	-	0.4	1.0	mA
V_{PSR}	Protection reset voltage ⁵	$T_J = 150\text{ °C}$	1.5	2.5	3.5	V
			1.0	-	-	V
$V_{(CL)PS}$	Protection clamp voltage	$I_p = 1.35\text{ mA}$	11	13	-	V

REVERSE DIODE CHARACTERISTICS

$T_{mb} = 25\text{ °C}$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{SDS}	Forward voltage	$I_S = 15\text{ A}$; $V_{IS} = V_{PS} = V_{FS} = 0\text{ V}$; $t_p = 300\text{ }\mu\text{s}$	-	1.0	1.5	V
t_{rr}	Reverse recovery time	not applicable ⁶	-	-	-	-

1 The short circuit load protection is able to save the device providing the instantaneous on-state dissipation is less than the limiting value for P_{DSM} , which is always the case when V_{DS} is less than V_{DSP} maximum.

2 At the appropriate nominal protection supply voltage for each type. Refer to QUICK REFERENCE DATA.

3 The over temperature protection feature requires a minimum on-state drain source voltage for correct operation. The specified minimum I_D ensures this condition.

4 During overload condition. Refer also to OVERLOAD PROTECTION LIMITING VALUES and CHARACTERISTICS.

5 The supply voltage below which the overload protection circuits will be reset.

6 The reverse diode of this type is not intended for applications requiring fast reverse recovery.

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INPUT CHARACTERISTICS

 $T_{mb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{IS(TO)}$	Normal operation Input threshold voltage	$V_{DS} = 5\text{ V}; I_D = 1\text{ mA}$ $T_{mb} = 150\text{ }^{\circ}\text{C}$	1.0	1.5	2.0	V
I_{IS}	Input current	$V_{IS} = 10\text{ V}$	0.5	-	-	V
$V_{(CL)IS}$	Input clamp voltage	$I_I = 1\text{ mA}$	-	10	100	nA
			11	13	-	V
R_{ISL}	Overload protection latched Input resistance ¹	$V_{PS} = 5\text{ V}$ $I_I = 5\text{ mA};$ $T_{mb} = 150\text{ }^{\circ}\text{C}$	-	55	-	Ω
		$V_{PS} = 10\text{ V}$ $I_I = 5\text{ mA};$ $T_{mb} = 150\text{ }^{\circ}\text{C}$	-	95	-	Ω
			-	35	-	Ω
			-	60	-	Ω
R_{IS}	Application information External input resistances for internal overvoltage clamping ²	(see figure 29) $R_I = \infty\text{ }\Omega;$ $V_{DS} > 30\text{ V}$	100	-	-	Ω
R_I	internal overload protection ³	$R_{IS} = \infty\text{ }\Omega;$ $V_{II} = 5\text{ V}$ $V_{II} = 10\text{ V}$	1 2	- -	- -	k Ω k Ω

SWITCHING CHARACTERISTICS

 $T_{mb} = 25\text{ }^{\circ}\text{C}; R_I = 50\text{ }\Omega; R_{IS} = 50\text{ }\Omega$ (see figure 29); resistive load $R_L = 10\text{ }\Omega$. For waveforms see figure 28.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t_{don}	Turn-on delay time	$V_{DD} = 15\text{ V}; V_{IS}: 0\text{ V} \Rightarrow 10\text{ V}$	-	8	-	ns
t_r	Rise time		-	13	-	ns
t_{doff}	Turn-off delay time	$V_{DD} = 15\text{ V}; V_{IS}: 10\text{ V} \Rightarrow 0\text{ V}$	-	100	-	ns
t_f	Fall time		-	45	-	ns

CAPACITANCES

 $T_{mb} = 25\text{ }^{\circ}\text{C}; f = 1\text{ MHz}$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
C_{ISS}	Input capacitance	$V_{DS} = 25\text{ V}; V_{IS} = 0\text{ V}$	-	415	600	pF
C_{OSS}	Output capacitance	$V_{DS} = 25\text{ V}; V_{IS} = 0\text{ V}$	-	275	400	pF
C_{RSS}	Reverse transfer capacitance	$V_{DS} = 25\text{ V}; V_{IS} = 0\text{ V}$	-	55	80	pF
C_{PSO}	Protection supply pin capacitance	$V_{PS} = 10\text{ V}$	-	30	-	pF
C_{FSO}	Flag pin capacitance	$V_{FS} = 10\text{ V}; V_{PS} = 0\text{ V}$	-	20	-	pF

1 The resistance of the internal transistor which discharges the power MOSFET gate capacitance when overload protection operates.

The external drive circuit should be such that the input voltage does not exceed $V_{IS(TO)}$ minimum when the overload protection has operated. Refer also to figure for latched input characteristics.

2 Applications using a lower value for R_{IS} would require external overvoltage protection.

3 For applications requiring a lower value for R_I , an external overload protection strategy is possible using the flag pin to 'tell' the control circuit to switch off the input.

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FLAG DESCRIPTION

The flag pin provides a means to detect the presence of the protection supply and indicate the state of the overload detectors. The flag is the open drain of an n-MOS transistor and requires an external pull-up resistor¹. It is suitable for both 5 V and 10 V logic. Flag may be used to implement an external protection strategy² for applications which require low input drive impedance.

TRUTH TABLE

CONDITION	DESCRIPTION	FLAG
NORMAL	Normal operation and adequate protection supply voltage	LOGIC LOW
OVER TEMP.	Over temperature detected	LOGIC HIGH
SHORT CIRCUIT	Overload condition detected	LOGIC HIGH
SUPPLY FAULT	Inadequate protection supply voltage	LOGIC HIGH

FLAG CHARACTERISTICS

$T_{mb} = 25\text{ }^{\circ}\text{C}$ unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{FS}	Flag 'low' Flag voltage	normal operation $I_F = 1.6\text{ mA}$	-	0.15	0.4	V
I_{FSS}	Flag saturation current	$V_{FS} = 10\text{ V}$	-	15	-	mA
I_{FS}	Flag 'high' Flag leakage current	overload or fault $V_{FS} = 10\text{ V}$	-	-	10	μA
V_{PSF}	Protection supply threshold voltage	$V_{FF} = 5\text{ V}$; $R_F = 3\text{ k}\Omega$; BUK114-50L BUK114-50S	2.5 3.3	3.3 4.2	4 5	V V
$V_{(CL)FS}$	Flag clamping voltage	$I_F = 1\text{ mA}$; $V_{PS} = 0\text{ V}$	11	13	-	V
R_F	Application information Suitable external pull-up resistance	$V_{FF} = 5\text{ V}$ $V_{FF} = 10\text{ V}$	1 2	10 20	50 100	k Ω k Ω

¹ Even if the flag pin is not used, it is recommended that it is connected to the protection supply via a pull-up resistor. It should not be left floating.

² Low pass filtering of the flag signal may be advisable to prevent false tripping.

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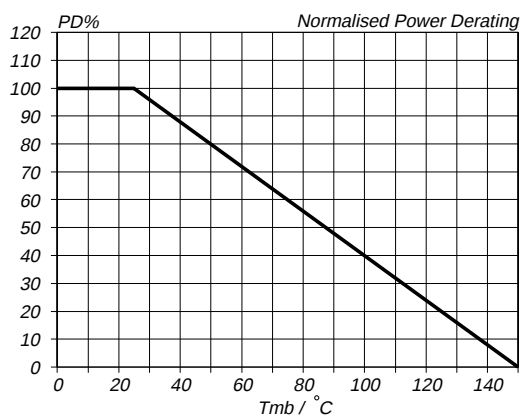


Fig.4. Normalised limiting power dissipation.
 $P_D\% = 100 \cdot P_D / P_D(25^\circ\text{C}) = f(T_{mb})$

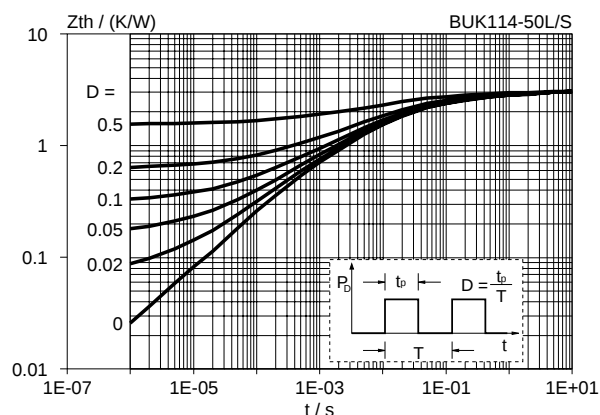


Fig.7. Transient thermal impedance.
 $Z_{th\ j-mb} = f(t)$; parameter $D = t_p / T$

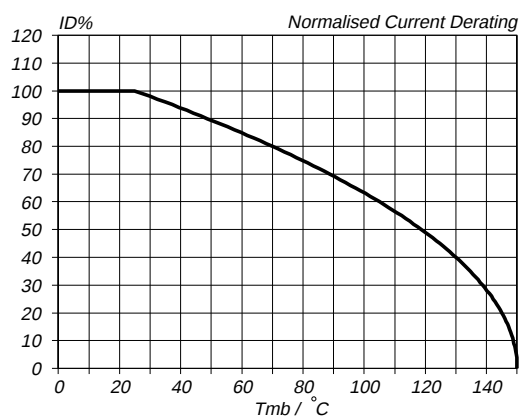


Fig.5. Normalised continuous drain current.
 $I_D\% = 100 \cdot I_D / I_D(25^\circ\text{C}) = f(T_{mb})$; conditions: $V_{IS} = 5\text{ V}$

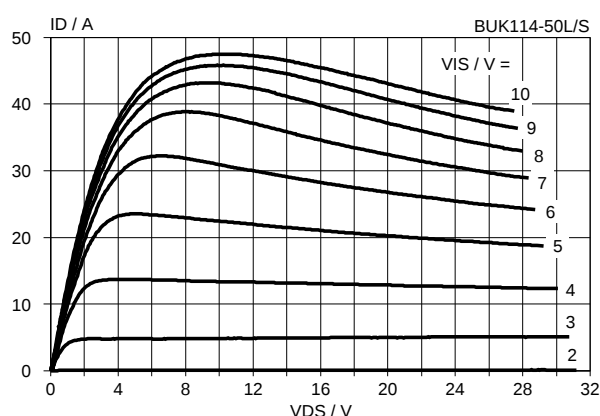


Fig.8. Typical output characteristics, $T_j = 25^\circ\text{C}$.
 $I_D = f(V_{DS})$; parameter V_{IS} ; $t_p = 250\ \mu\text{s}$ & $t_p < t_{dsc}$

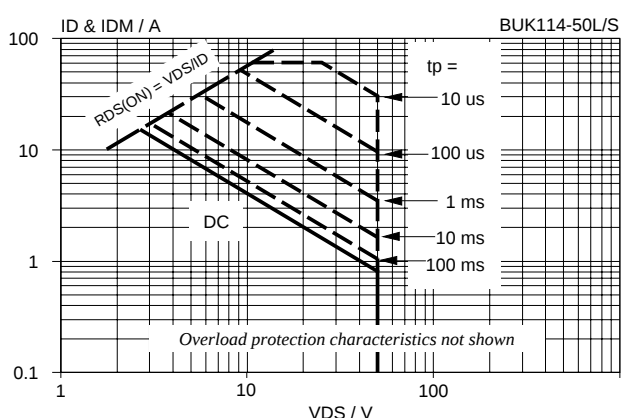


Fig.6. Safe operating area. $T_{mb} = 25^\circ\text{C}$
 I_D & $I_{DM} = f(V_{DS})$; I_{DM} single pulse; parameter t_p

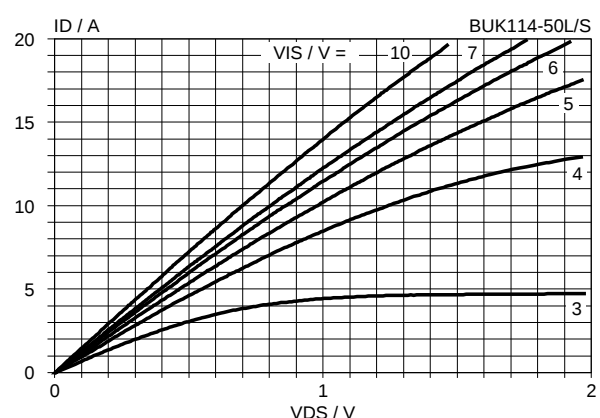
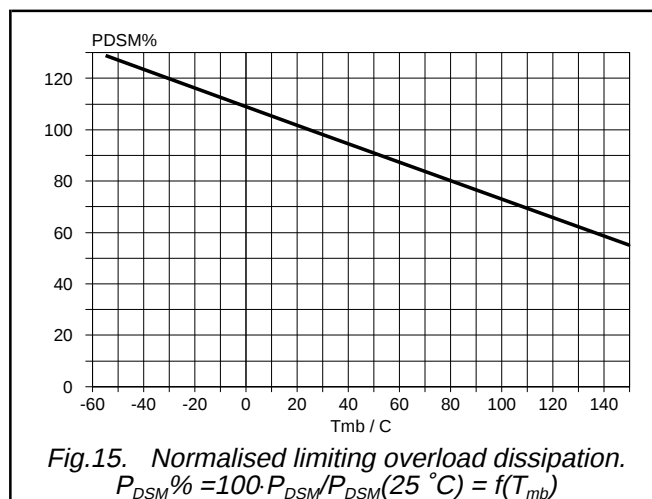
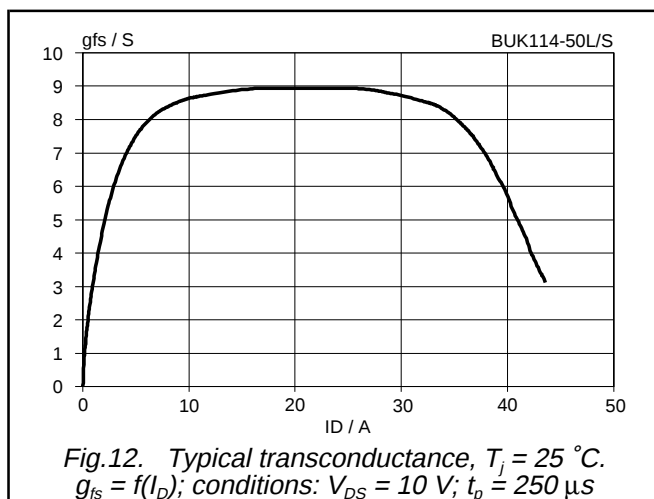
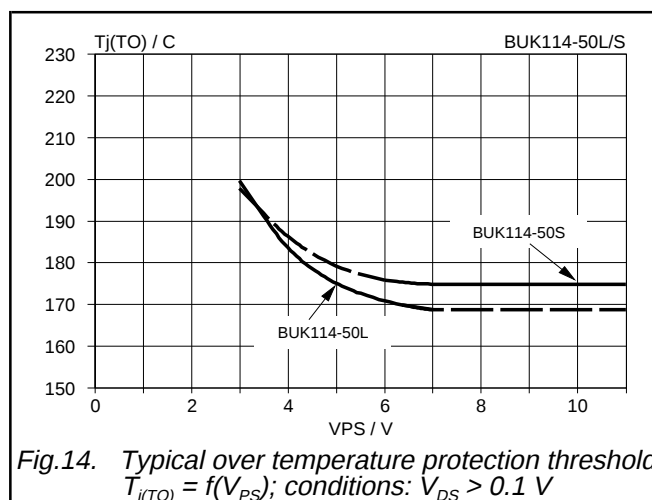
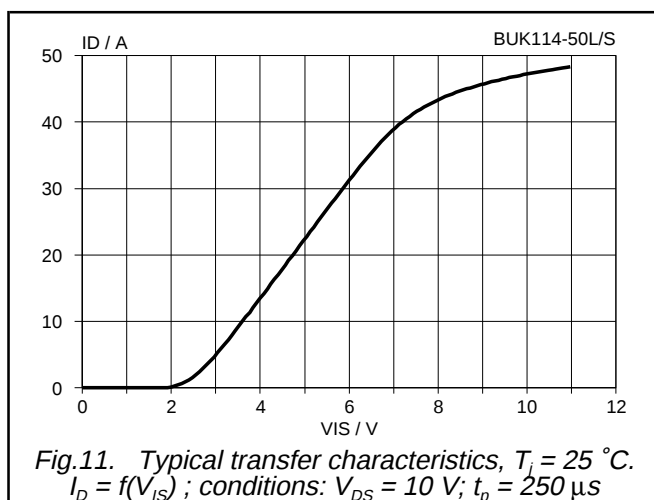
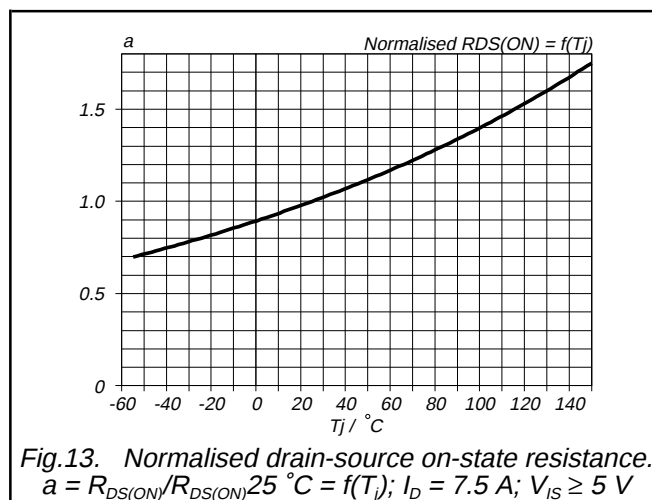
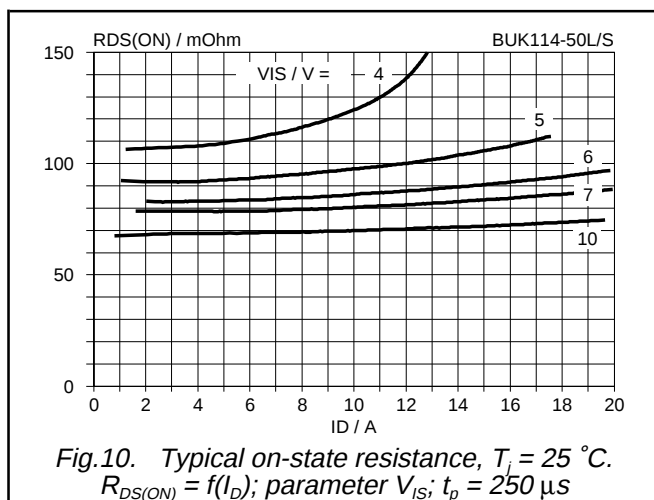


Fig.9. Typical on-state characteristics, $T_j = 25^\circ\text{C}$.
 $I_D = f(V_{DS})$; parameter V_{IS} ; $t_p = 250\ \mu\text{s}$

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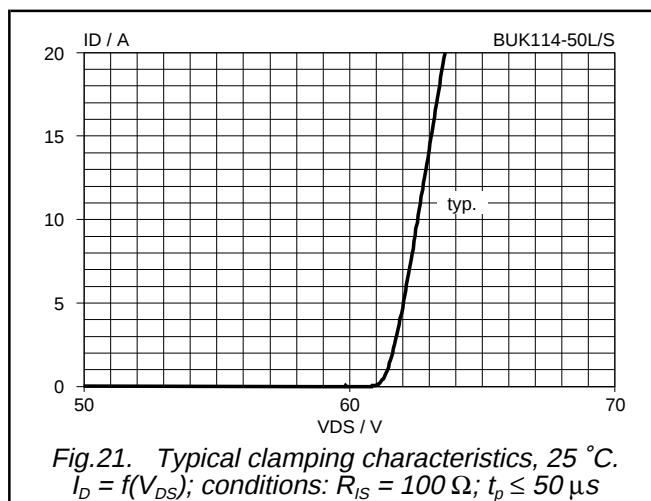
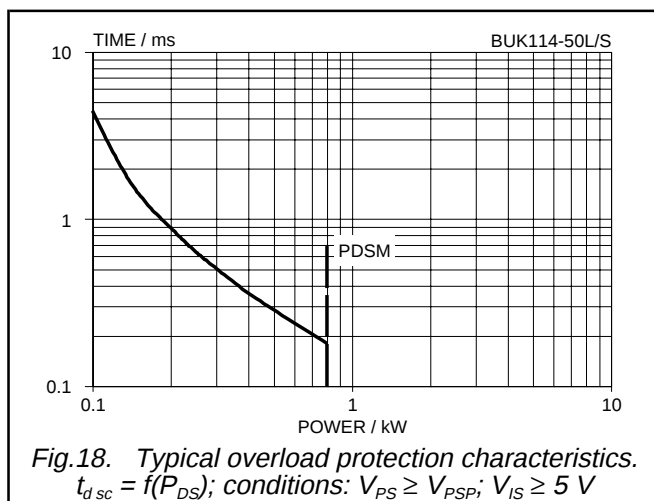
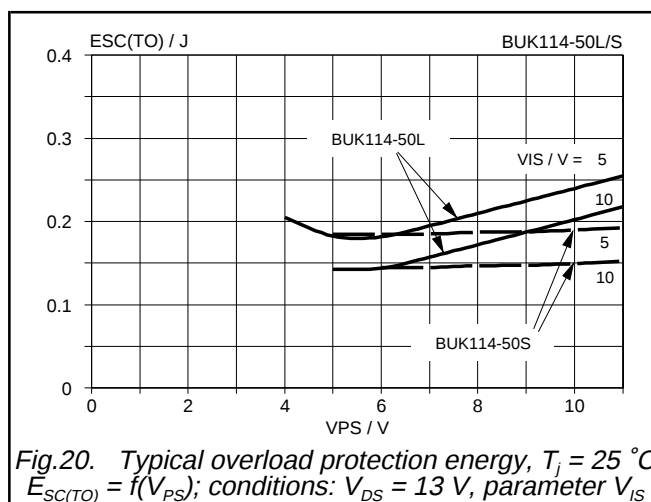
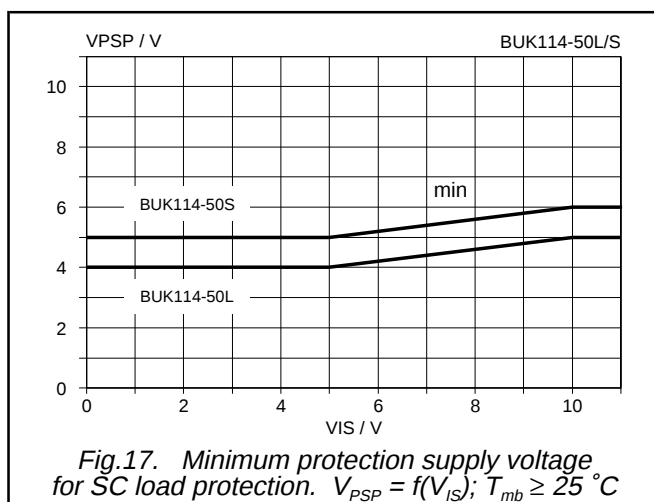
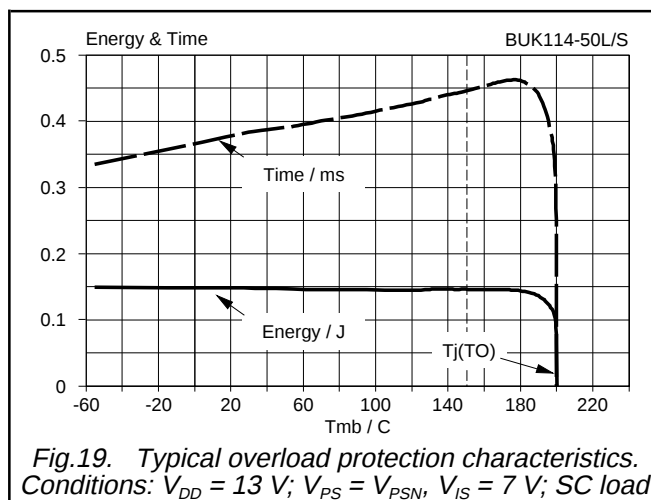
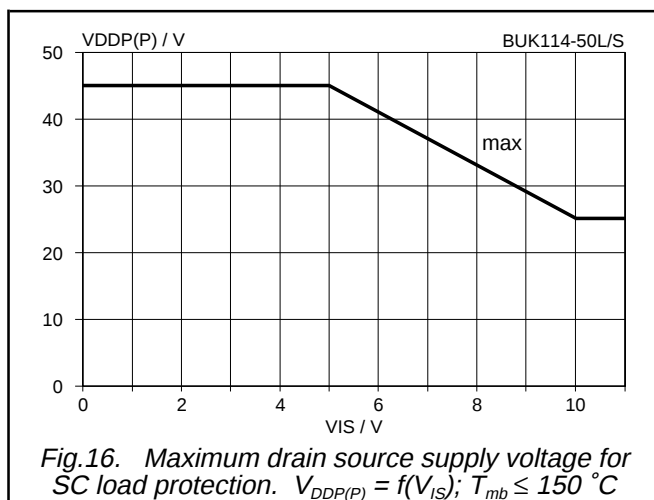
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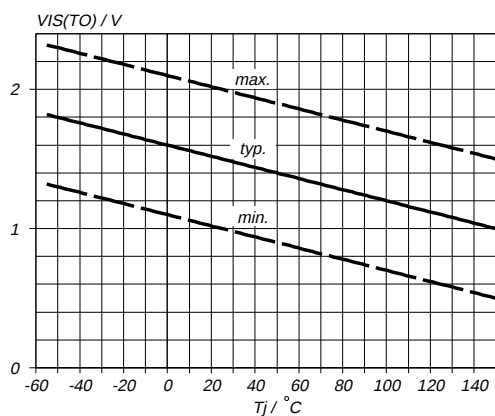


Fig.22. Input threshold voltage.
 $V_{IS(TO)} = f(T_J)$; conditions: $I_D = 1 \text{ mA}$; $V_{DS} = 5 \text{ V}$

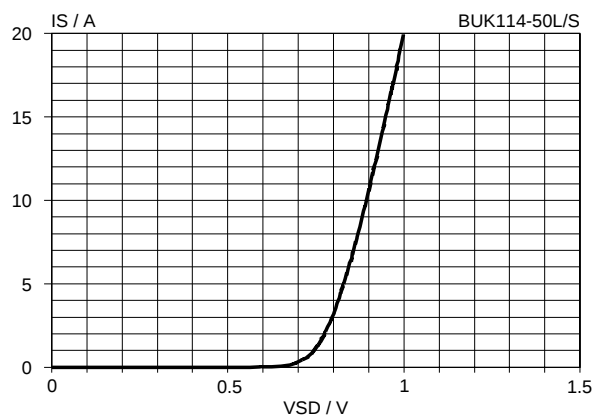


Fig.25. Typical reverse diode current, $T_J = 25^\circ\text{C}$.
 $I_S = f(V_{SDS})$; conditions: $V_{IS} = 0 \text{ V}$; $t_p = 250 \mu\text{s}$

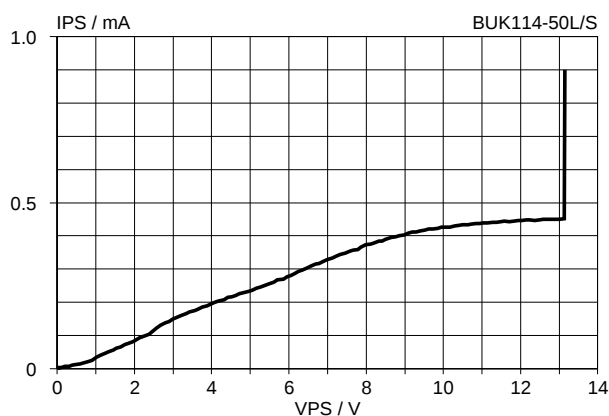


Fig.23. Typical DC protection supply characteristics.
 $I_{PS} = f(V_{PS})$; normal or overload operation; $T_J = 25^\circ\text{C}$

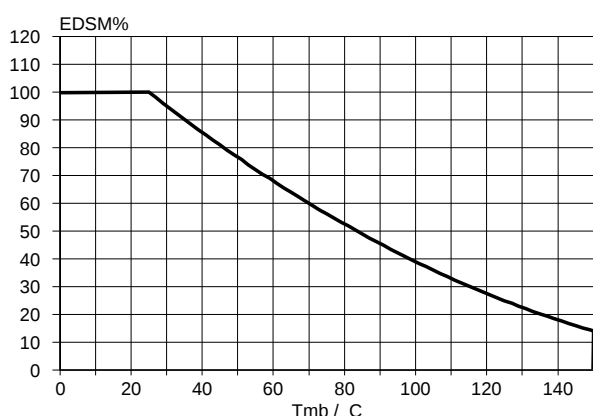


Fig.26. Normalised limiting clamping energy.
 $E_{DSM}\% = f(T_{mb})$; conditions: $I_D = 15 \text{ A}$

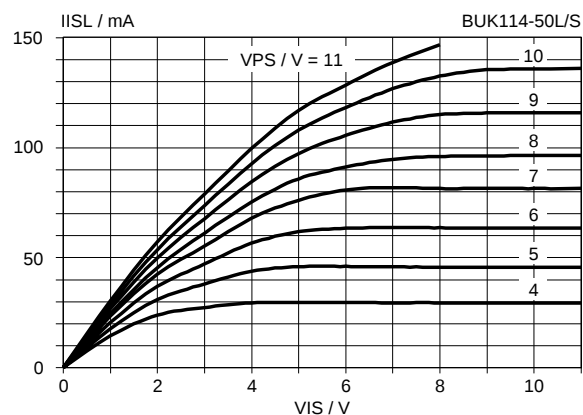


Fig.24. Typical latched input characteristics, 25°C .
 $I_{ISL} = f(V_{IS})$; after overload protection latched

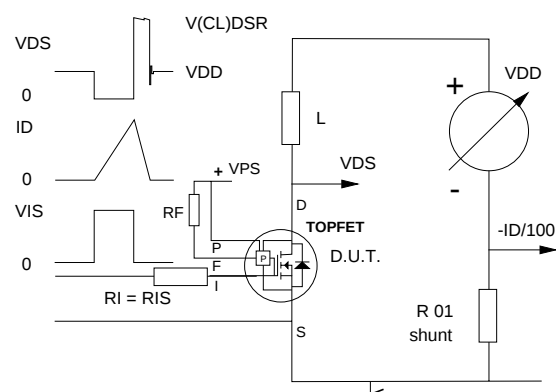
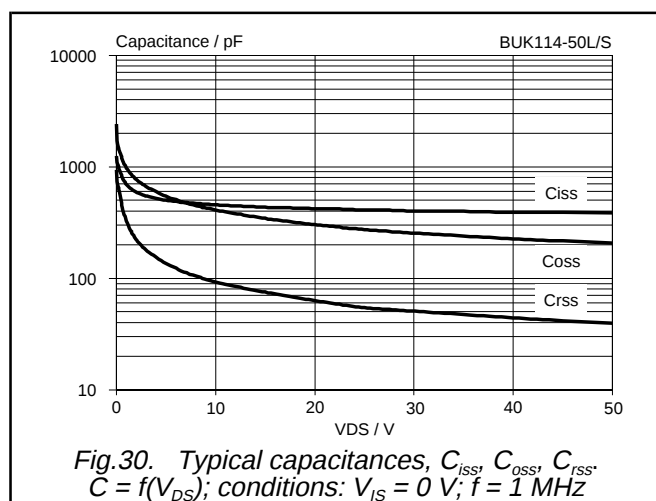
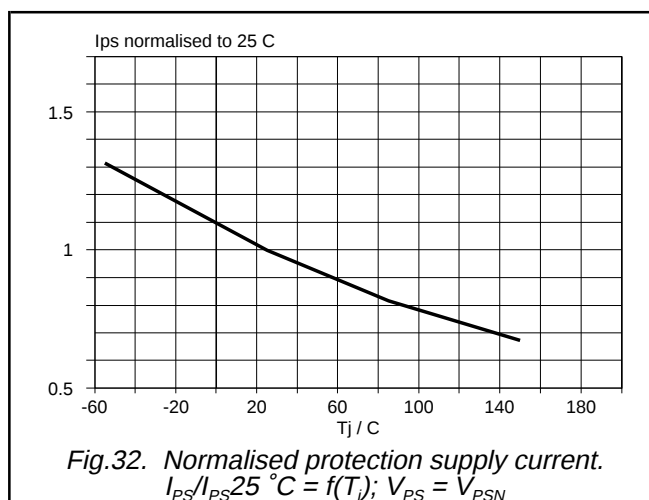
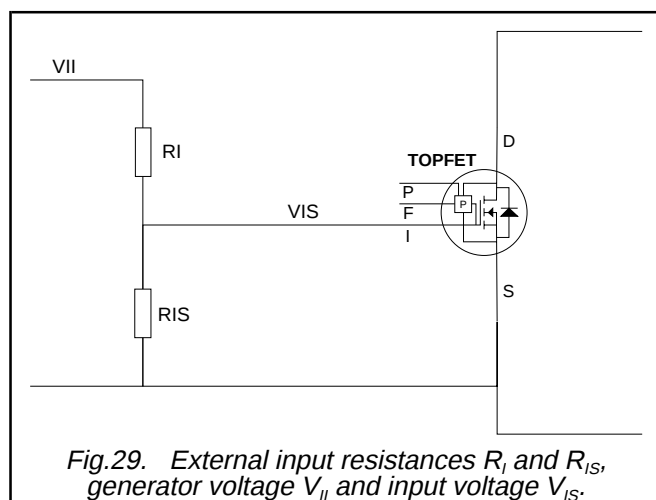
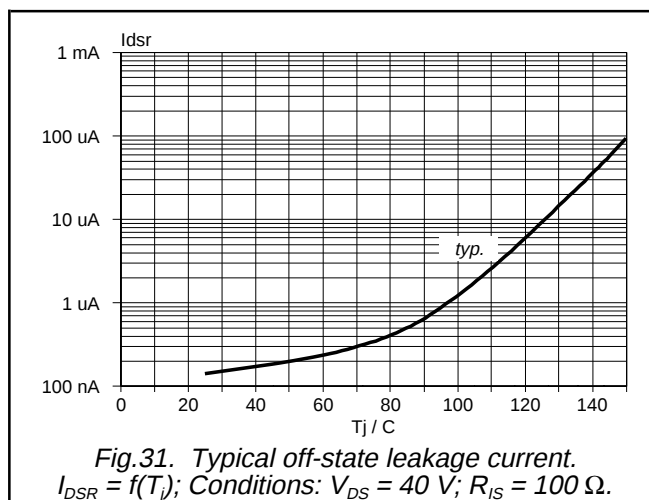
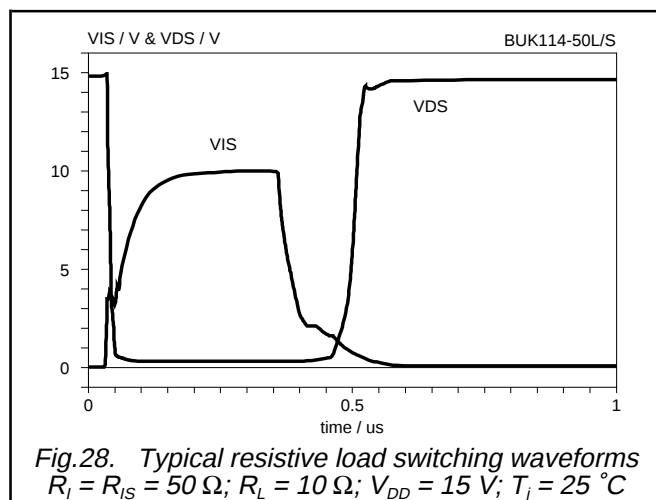


Fig.27. Clamping energy test circuit, $R_{IS} = 100 \Omega$.
 $E_{DSM} = 0.5 \cdot L I_D^2 \cdot V_{(CL)DSR} / (V_{(CL)DSR} - V_{DD})$

Logic level TOPFET

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Logic level TOPFET
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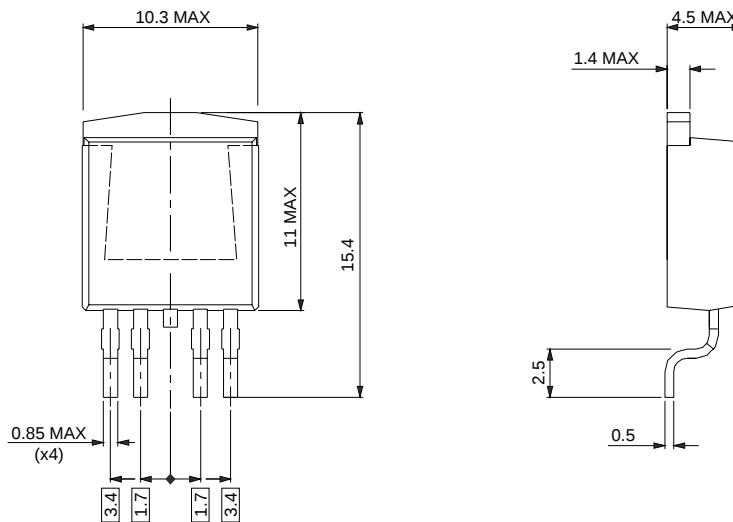
MECHANICAL DATA*Dimensions in mm**Net Mass: 1.5 g*

Fig.33. SOT426

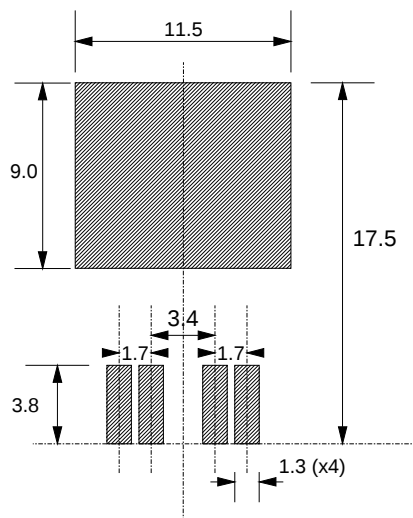
*mounting base connected to centre pin (cropped short)***MOUNTING INSTRUCTIONS***Dimensions in mm*

Fig.34. SOT426

soldering pattern for surface mounting.

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DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	
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